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Description

The DIODES™ DGTD65T50S1PT is produced using advanced Field Stop Trench IGBT Technology, which provides excellent quality and high switching performance.

Features

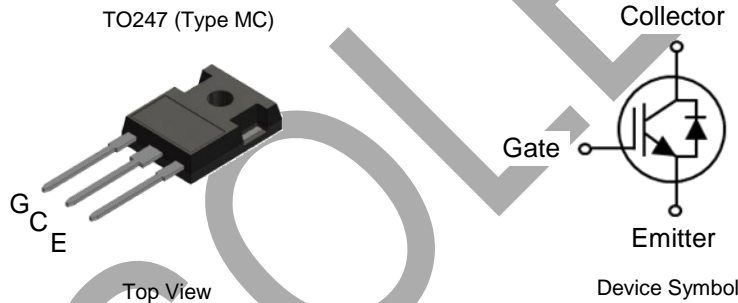
- High-Speed Switching & Low Power Loss
- $V_{CE(sat)} = 1.85V @ I_C = 50A$
- High Input Impedance
- $t_{rr} = 80ns$ (Typ) @ $dI_F/dt = 1000A/\mu s$
- $E_{off} = 0.55mJ @ T_C = +25^\circ C$
- Maximum Junction Temperature $175^\circ C$
- **Lead-Free Finish & RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/contact-us) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Applications

- UPS
- Welders
- Solar inverters
- IH cookers

Mechanical Data

- Package: TO247
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 5.6 grams (Approximate)



Ordering Information (Note 4)

Part Number	Package	Marking	Packing	
			Qty.	Carrier
DGTD65T50S1PT	TO247 (Type MC)	DGTD65T50S1	450	Per Box in Tubes (Note 5)

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
 5. 30 devices per tube.

Marking Information



- DII = Manufacturer's Marking
- DGTD65T50S1 = Product Type Marking Code
- YY = Year (ex: 22 = 2022)
- LLLLL = Lot Code
- WW = Week (01 to 53)

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CE}	650	V
DC Collector Current, Limited by T _{vjmax}	I _C	T _C = +25°C	100
		T _C = +100°C	50
Pulsed Collector Current, t _p Limited by T _{vjmax}	I _{Cpuls}	200	A
Turn Off Safe Operating Area V _{CE} ≤ 650V, T _{vj} = +175°C	—	200	A
Diode Forward Current Limited by T _{vjmax}	I _F	T _C = +25°C	60
		T _C = +100°C	30
Diode Pulsed Current, t _p Limited by T _{vjmax}	I _{Fpuls}	200	A
Gate-Emitter Voltage	V _{GE}	±20	V
Short Circuit Withstand Time V _{CC} ≤ 400V, V _{GE} = 15V, T _{vj} = +150°C Allowed Number of Short Circuits < 1000 Time Between Short Circuits ≥ 1.0s	t _{sc}	5	μs

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 6)	P _D	T _C = +25°C	375
		T _C = +100°C	188
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	40	°C/W
Thermal Resistance, Junction to Case for IGBT (Note 6)	R _{θJC}	0.40	
Thermal Resistance, Junction to Case for Diode (Note 6)	R _{θJC}	1.20	
Operating Temperature	T _{vj}	-40 to +175	°C
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 6. When mounted on a standard JEDEC 2-layer FR-4 board.

Electrical Characteristics (@T_{vj} = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Typ	Max	Unit	Condition
STATIC CHARACTERISTICS						
Collector-Emitter Breakdown Voltage	BV _{CES}	650	—	—	V	I _C = 2mA, V _{GE} = 0V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	1.85	2.40	V	I _C = 50A, V _{GE} = 15V
		—	2.20	—		
Diode Forward Voltage	V _F	—	1.65	2.05	V	V _{GE} = 0V, I _F = 30A
		—	1.55	—		
Gate-Emitter Threshold Voltage	V _{GE(th)}	3.8	5.0	6.2	V	V _{CE} = V _{GE} , I _C = 0.5mA
Zero Gate Voltage Collector Current	I _{CES}	—	—	40	μA	V _{CE} = 650V, V _{GE} = 0V
Gate-Emitter Leakage Current	I _{GES}	—	—	±100	nA	V _{GE} = 20V, V _{CE} = 0V
DYNAMIC CHARACTERISTICS						
Total Gate Charge	Q _g	—	287	—	nC	V _{CE} = 520V, I _C = 50A V _{GE} = 15V
Gate-Emitter Charge	Q _{ge}	—	42	—		
Gate-Collector Charge	Q _{gc}	—	181	—		
Input Capacitance	C _{ies}	—	4,453	—	pF	V _{CE} = 25V, V _{GE} = 0V f = 1MHz
Reverse Transfer Capacitance	C _{res}	—	161	—		
Output Capacitance	C _{oes}	—	238	—		
Internal Emitter Inductance Measured 5mm (0.197") from Case	L _E	—	13	—	nH	—
Short Circuit Collector Current Max. 1000 Short Circuits. Time Between Short Circuits ≥ 1.0s	I _{C(SC)}	—	140	—	A	V _{GE} = 15V, V _{CC} = 400V t _{SC} ≤ 5μs, T _{vj} = +150°C
SWITCHING CHARACTERISTICS						
Turn-on Delay Time	t _{d(on)}	—	58	—	ns	V _{GE} = 15V, V _{CC} = 400V I _C = 50A, R _G = 7.9Ω Inductive Load T _{vj} = +25°C
Rise Time	t _r	—	60	—		
Turn-off Delay Time	t _{d(off)}	—	328	—		
Fall Time	t _f	—	44	—		
Turn-on Switching Energy	E _{on}	—	0.77	—	mJ	
Turn-off Switching Energy	E _{off}	—	0.55	—		
Total Switching Energy	E _{ts}	—	1.32	—		
Reverse Recovery Time	t _{rr}	—	80	—	ns	
Reverse Recovery Current	I _{rr}	—	24	—	A	
Reverse Recovery Charge	Q _{rr}	—	0.95	—	μC	
Turn-on Delay Time	t _{d(on)}	—	51	—	ns	V _{GE} = 15V, V _{CC} = 400V I _C = 50A, R _G = 7.9Ω Inductive Load T _{vj} = +175°C
Rise Time	t _r	—	66	—		
Turn-off Delay Time	t _{d(off)}	—	350	—		
Fall Time	t _f	—	49	—		
Turn-on Switching Energy	E _{on}	—	1.05	—	mJ	
Turn-off Switching Energy	E _{off}	—	0.55	—		
Total Switching Energy	E _{ts}	—	1.6	—		
Reverse Recovery Time	t _{rr}	—	116	—	ns	
Reverse Recovery Current	I _{rr}	—	34	—	A	
Reverse Recovery Charge	Q _{rr}	—	1.97	—	μC	

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Typical Performance Characteristics (@T_A = +25°C, unless otherwise specified.)

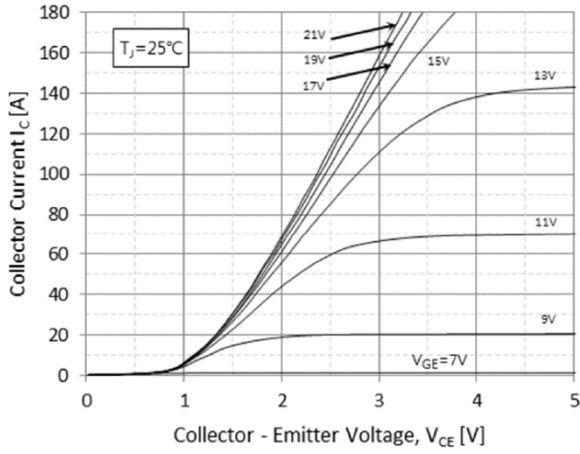


Fig.1 Typical Output Characteristics (T_J=25°C)

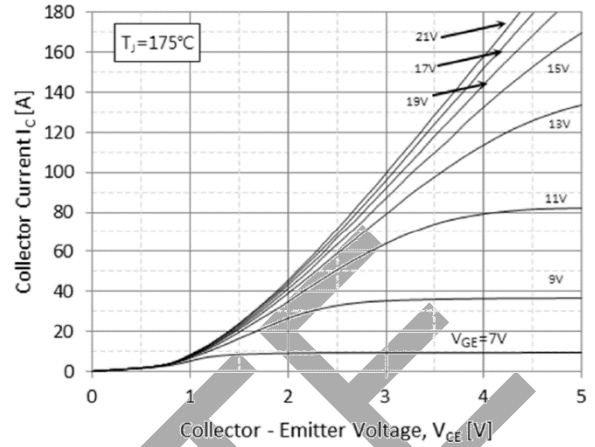


Fig.2 Typical Output Characteristics (T_J=175°C)

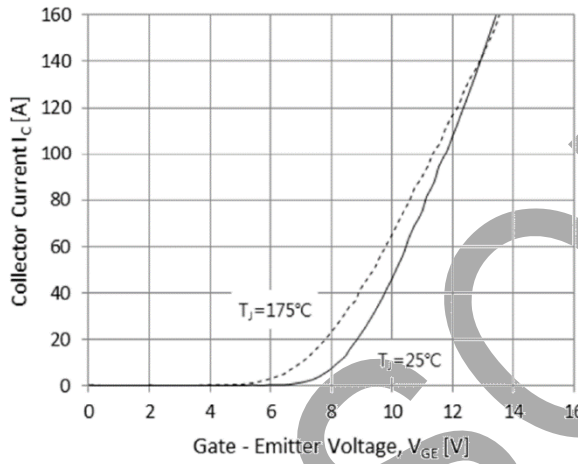


Fig.3 Typical Transfer Characteristics

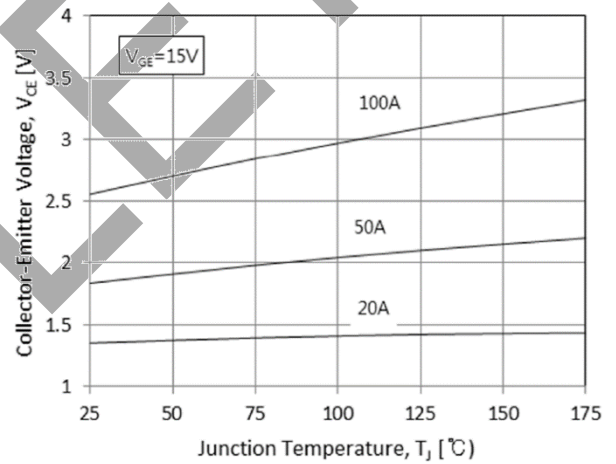


Fig.4 Typical Collector-Emitter Saturation Voltage - Junction Temperature

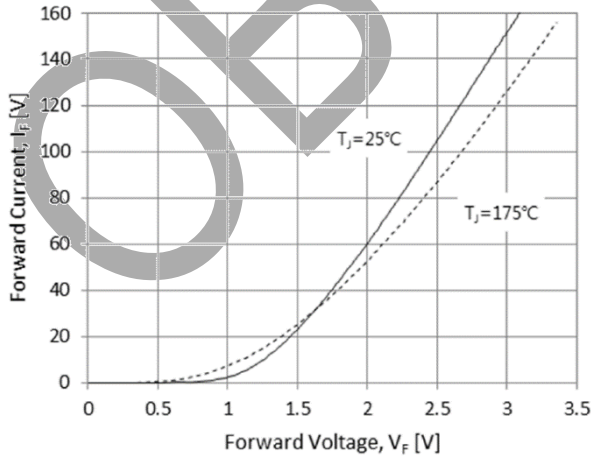


Fig.5 Diode Forward Characteristics

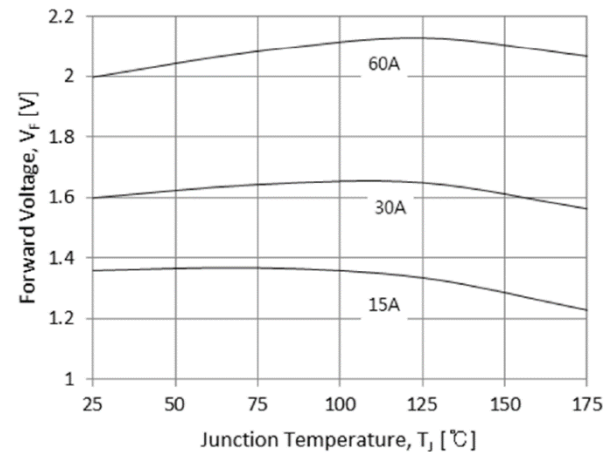


Fig.6 Diode Forward-Junction Temperature

Typical Performance Characteristics (continued)

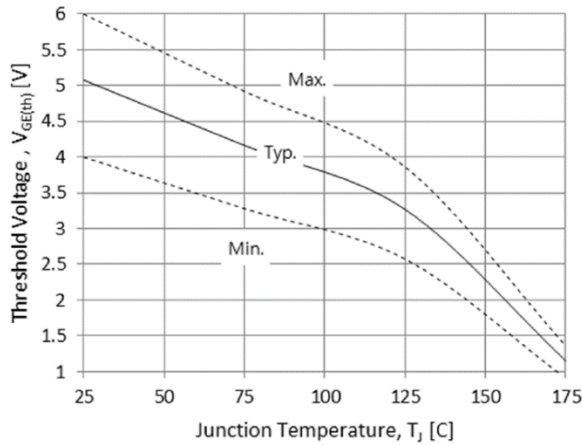


Fig.7 Threshold Voltage-Junction Temperature

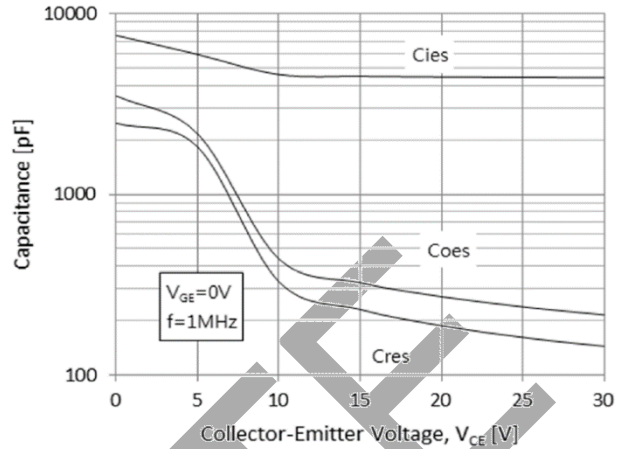


Fig.8 Typical Capacitance

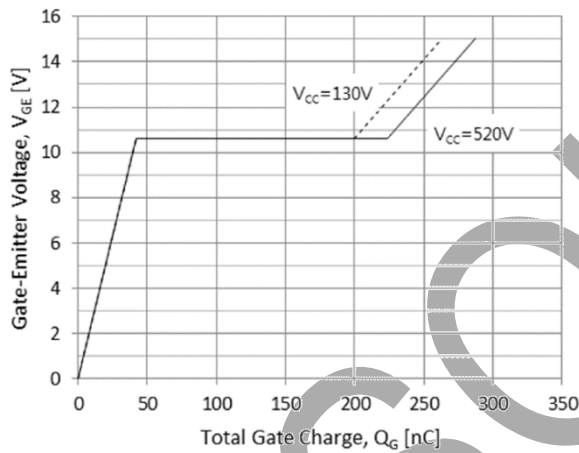


Fig.9 Typical Gate Charge

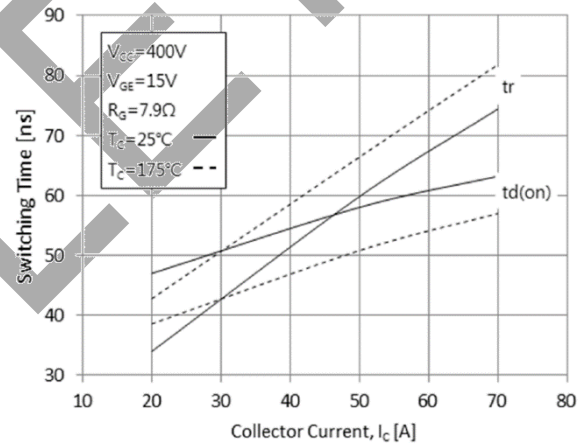


Fig.10 Typical Turn on-Collector Current

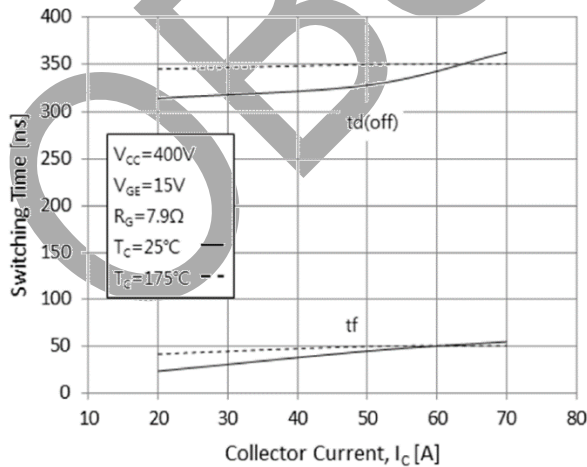


Fig.11 Typical Turn off-Collector Current

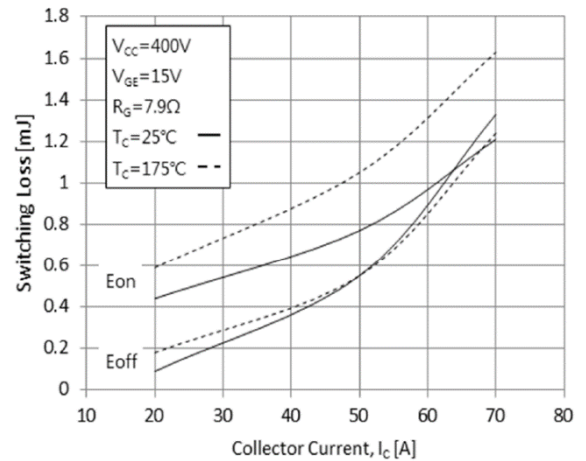


Fig.12 Switching Loss-Collector Current

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Typical Performance Characteristics (continued)

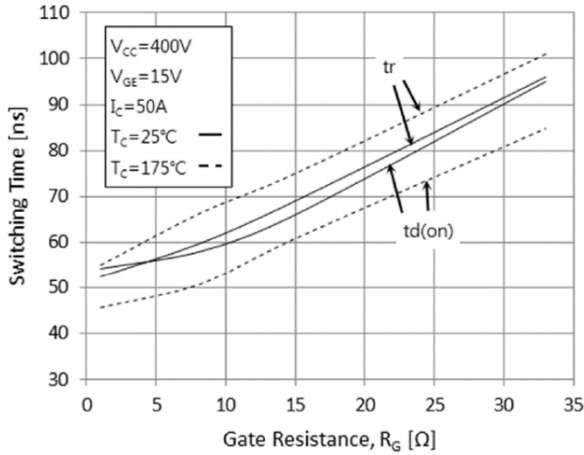


Fig.13 Turn on Characteristics-Gate Resistance

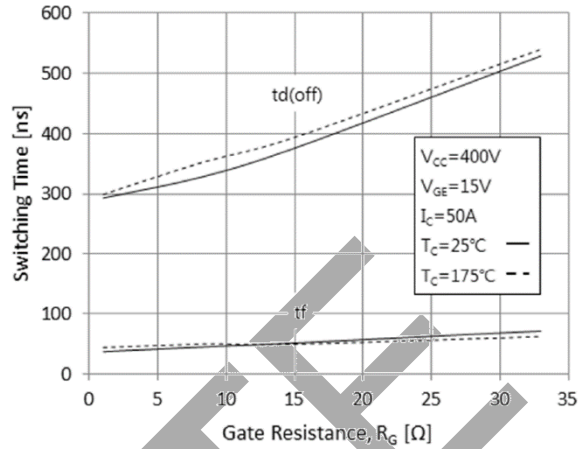


Fig.14 Turn off Characteristics-Gate Resistance

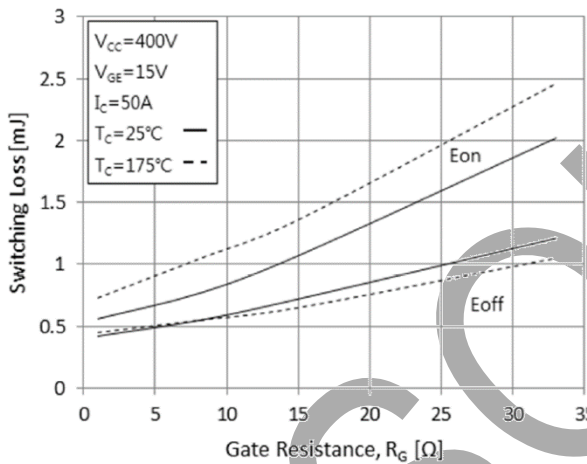


Fig.15 Switching Loss-Gate Resistance

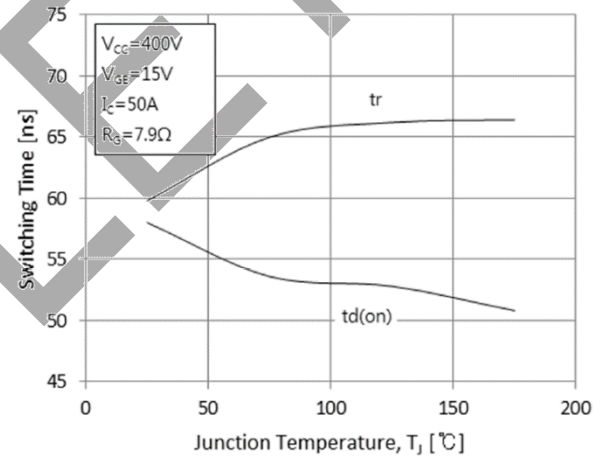


Fig.16 Turn on Characteristics-Junction Temperature

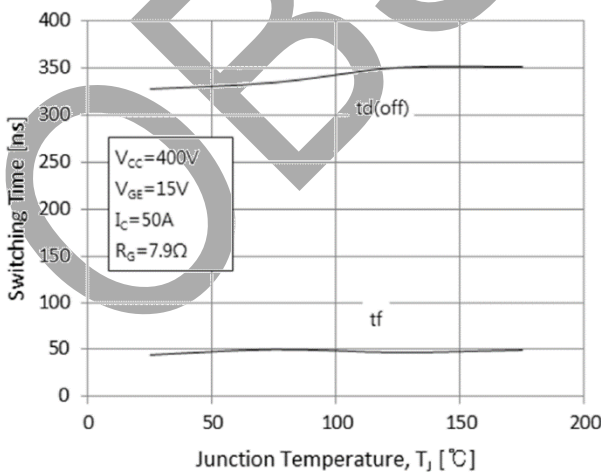


Fig.17 Turn off Characteristics-Junction Temperature

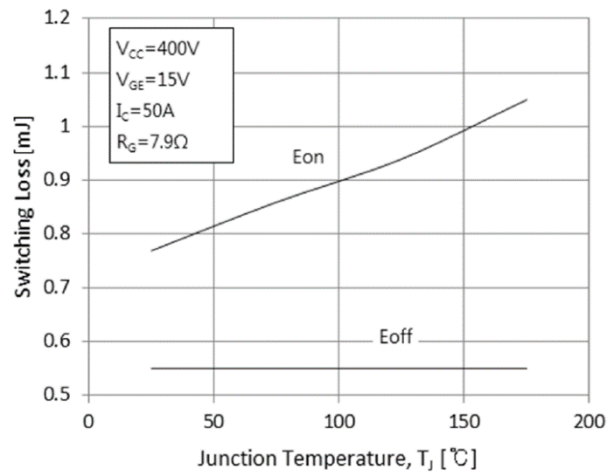


Fig.18 Switching Loss-Junction Temperature

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Typical Performance Characteristics (continued)

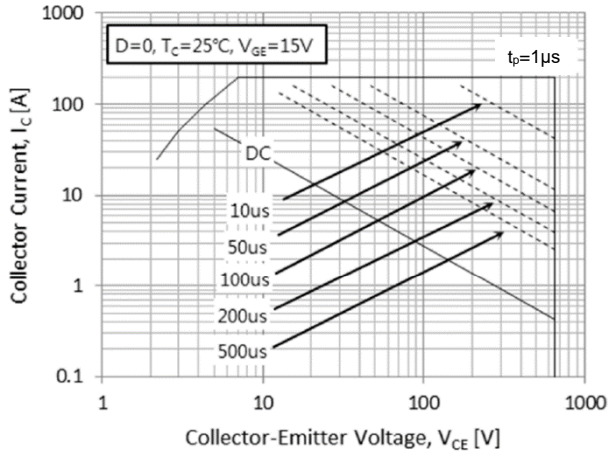


Fig.19 Forward Bias Safe Operating Area

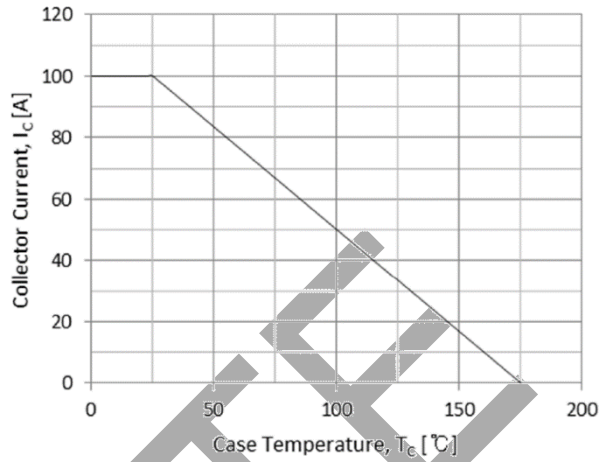


Fig.20 Case Temperature-Collector Current

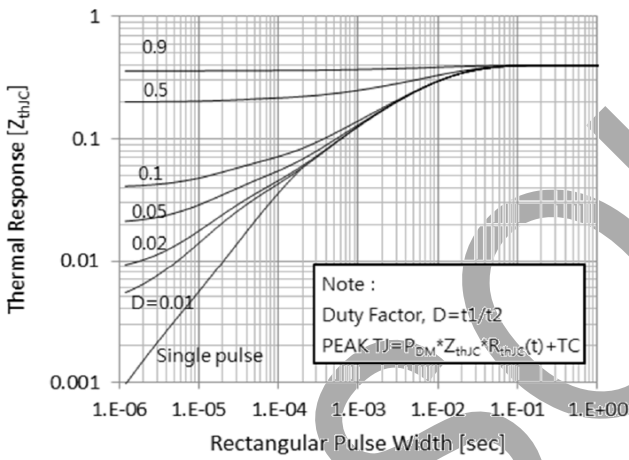


Fig.21 IGBT Transient Thermal Impedance

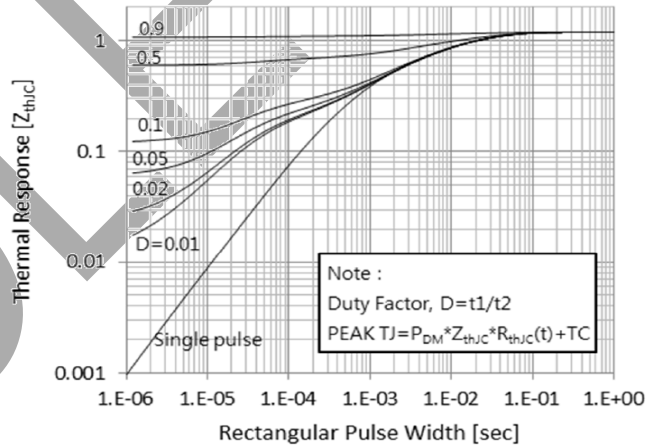


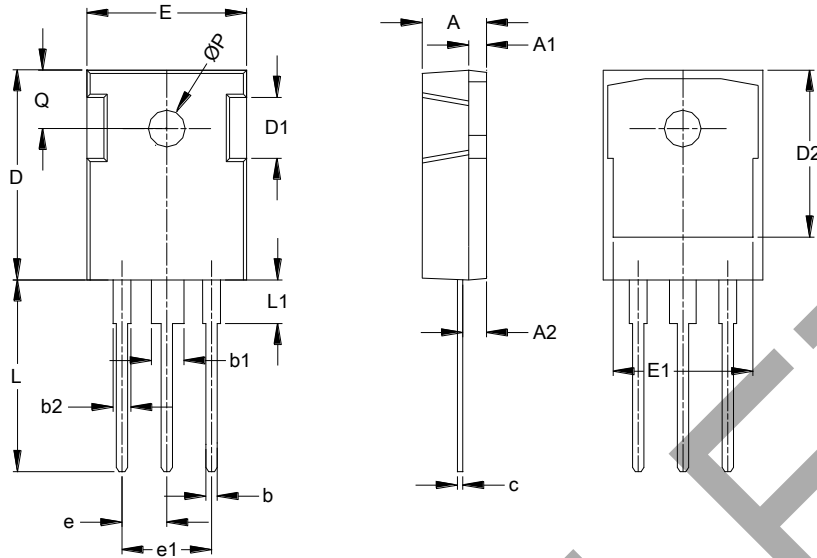
Fig.22 FRD Transient Thermal Impedance

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Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

TO247 (Type MC)



TO-247 (Type MC)			
Dim	Min	Max	Typ
A	4.700	5.310	-
A1	1.500	2.490	-
A2	2.200	2.600	-
b	0.990	1.400	-
b1	2.590	3.430	-
b2	1.650	2.390	-
c	0.380	0.890	-
D	20.30	21.46	-
D1	4.320	5.490	-
D2	13.08	-	-
E	15.45	16.26	-
E1	13.06	14.02	-
e	5.450		-
e1	10.90		-
L	19.81	20.57	-
L1	-	4.500	-
Q	5.380	6.200	-
øP	3.500	3.700	-
All Dimensions in mm			

Note: 7. For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.

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